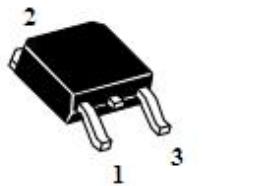
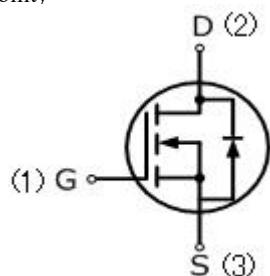


## 70N03(G,D)L

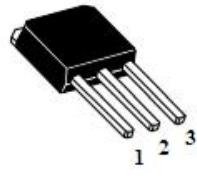
70 Amps,30 Volts N-CHANNEL Power MOSFET

### FEATURE

- 70A,30V, $R_{DS(ON)MAX}=6.0\text{m}\Omega$   $V_{GS}=10\text{V}/4\text{A}$   
 $R_{DS(ON)MAX}=9.0\text{m}\Omega$   $V_{GS}=4.5\text{V}/4\text{A}$
- Low gate charge
- Low  $C_{iss}$
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability



TO-252-2L  
70N03GL



TO-251-3L  
70N03DL

### Absolute Maximum Ratings( $T_c=25^\circ\text{C}$ ,unless otherwise noted)

Parameter	Symbol	70N03(G,D)L	UNIT
Drain-Source Voltage	$V_{DSS}$	30	V
Gate-Source Voltage	$V_{GSS}$	$\pm 20$	
Continuous Drain Current	$I_D$	70	A
Pulsed Drain Current(Note 1)	$I_{DM}$	230	
Single Pulse Avalanche Energy (Note 2)	$E_{AS}$	120	mJ
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to +150	°C
Channel Temperature	$T_{CH}$	150	°C
Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	$T_L$	260	°C

### Thermal Characteristics

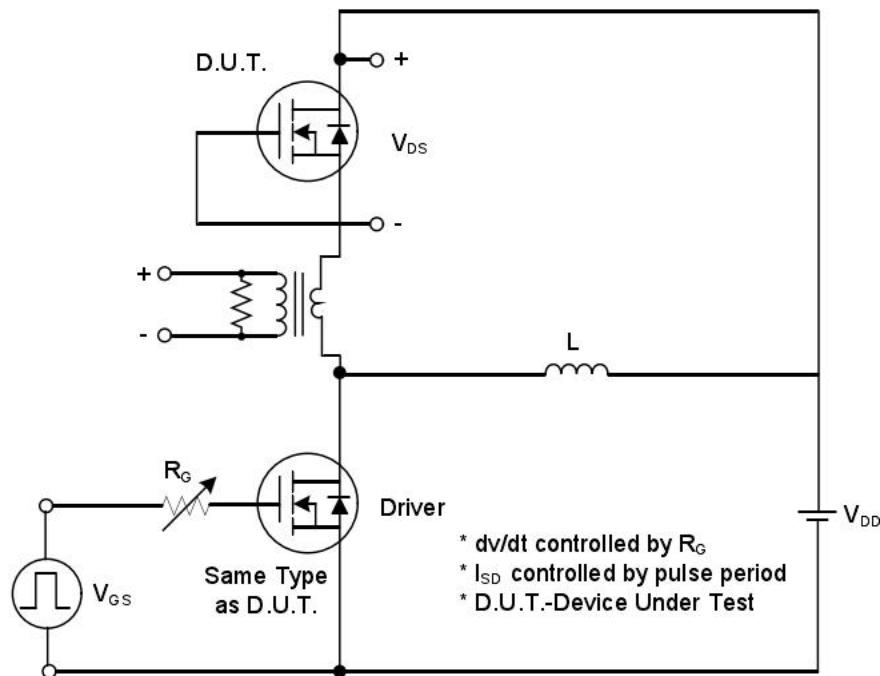
Parameter	Symbol	MAX	Units
Thermal resistance , Channel to Case	$R_{th(ch-c)}$	1.92	°C/W
Maximum Power Dissipation	$T_c=25^\circ\text{C}$	65	W

Electrical Characteristics ( $T_c=25^\circ\text{C}$ ,unless otherwise noted)						
Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	30	—	—	V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}}=30\text{V}, V_{\text{GS}}=0\text{V}$	—	—	1	$\mu\text{A}$
Gate-Body Leakage Current,Forward	$I_{\text{GSS}}$	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	—	—	$\pm 100$	nA
<b>On Characteristics</b>						
Gate-Source Threshold Voltage	$V_{\text{GS(th)}}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	1.0	—	2.5	V
Drain-Source On-State Resistance	$R_{\text{DS(on)}}$	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=4\text{A}$	—	4.7	6	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=4\text{A}$	—	6.5	9	
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}}=25\text{V}, V_{\text{GS}}=0\text{V}, f=1.0\text{MHz}$	—	2776	—	pF
Output Capacitance	$C_{\text{oss}}$		—	236	—	pF
Reverse Transfer Capacitance	$C_{\text{rss}}$		—	120	—	pF
<b>Switching Characteristics</b>						
Turn-On Delay Time	$t_{\text{d(on)}}$	$V_{\text{GS}}=10\text{V}, \text{VDD}=15\text{V}, RG_{\text{ext}}=2.7\Omega, ID=25\text{A}, f=1\text{MHz}$	—	16	—	ns
Turn-On Rise Time	$t_r$		—	12	—	ns
Turn-Off Delay Time	$t_{\text{d(off)}}$		—	69	—	ns
Turn-Off Fall Time	$t_f$		—	21	—	ns
Total Gate Charge	$Q_g$	$V_{\text{GS}}=10\text{V}, V_{\text{DS}}=24\text{V}, ID=25\text{A}, f=1\text{MHz}$	—	57	—	nC
Gate-Source Charge	$Q_{\text{gs}}$		—	13	—	nC
Gate-Drain Charge	$Q_{\text{gd}}$		—	12	—	nC
<b>Drain-Source Body Diode Characteristics and Maximum Ratings</b>						
Diode Forward Voltage	$V_{\text{SD}}$	$I_s=20\text{A}, V_{\text{GS}}=0\text{V}$	—	—	1.3	V
Reverse Recovery Time	$t_{\text{rr}}$	$I_F=15\text{A}, dI_F/dt=100\text{A/us}$	—	14	—	ns
Reverse Recovery Charge	$Q_{\text{rr}}$		—	7	—	nC

### Notes

1. Repetitive Rating:pulse width limited by maximum junction temperature.
2.  $L=0.5\text{mH}$  , starting  $T_j=25^\circ\text{C}$ .
3. Pulse width $\leq 300\text{us}$ ;duty cycle $\leq 2\%$ .

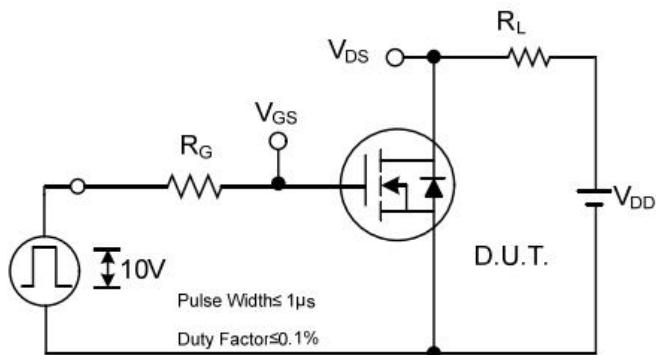
## RATING AND CHARACTERISTIC CURVES



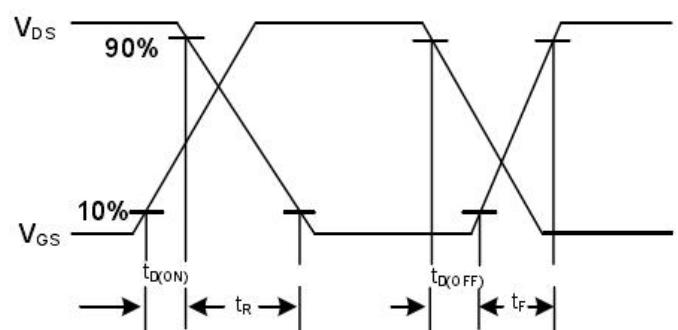
Peak Diode Recovery  $dv/dt$  Test Circuit



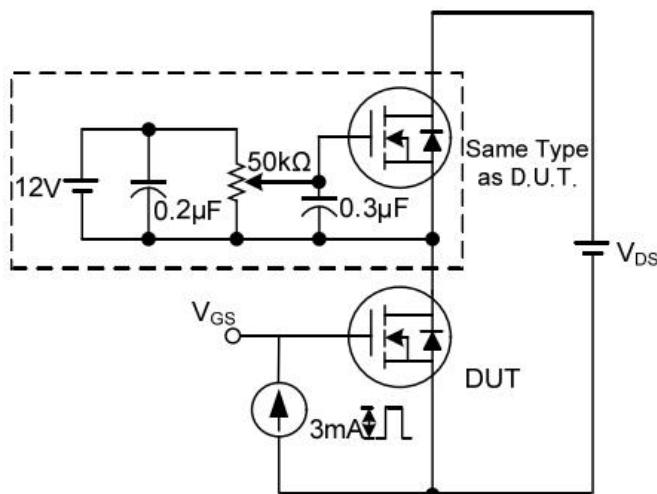
Peak Diode Recovery  $dv/dt$  Waveforms



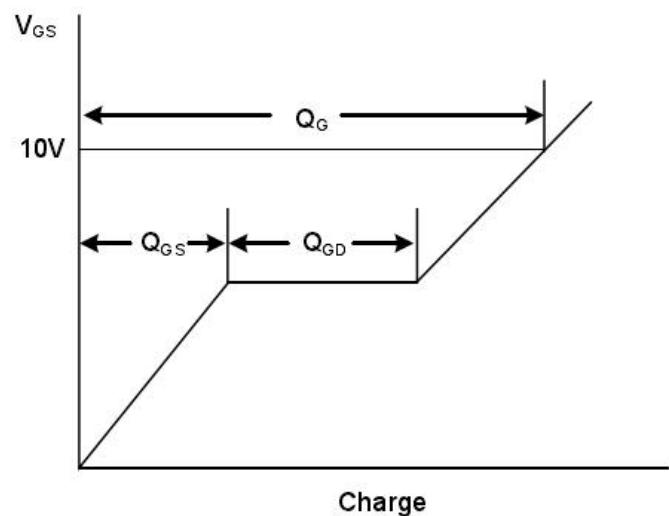
Switching Test Circuit



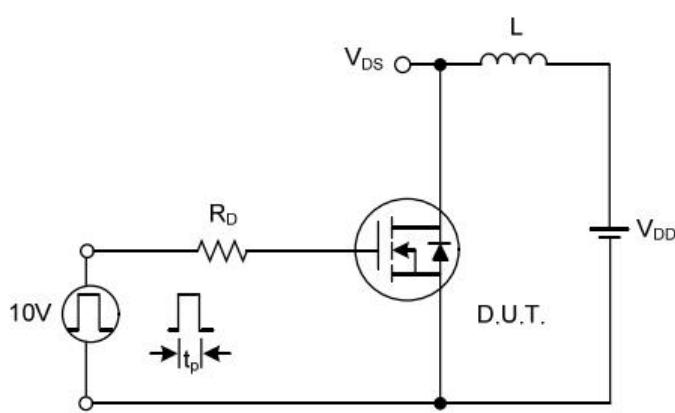
Switching Waveforms



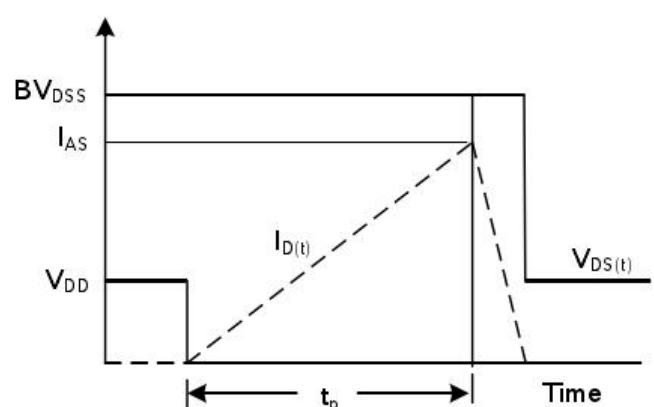
Gate Charge Test Circuit



Gate Charge Waveform

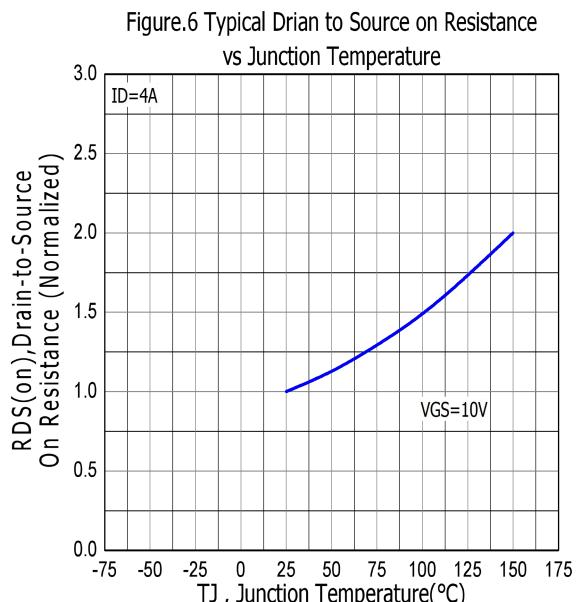
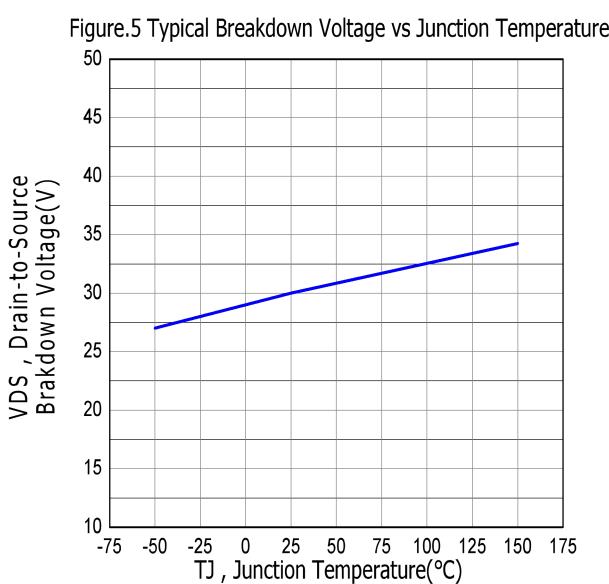
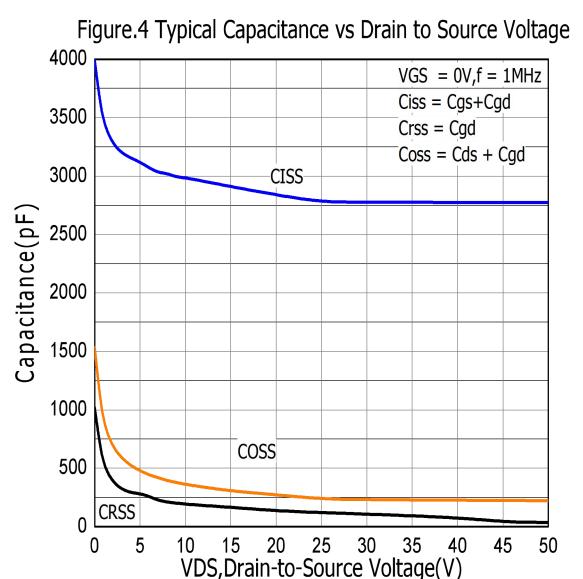
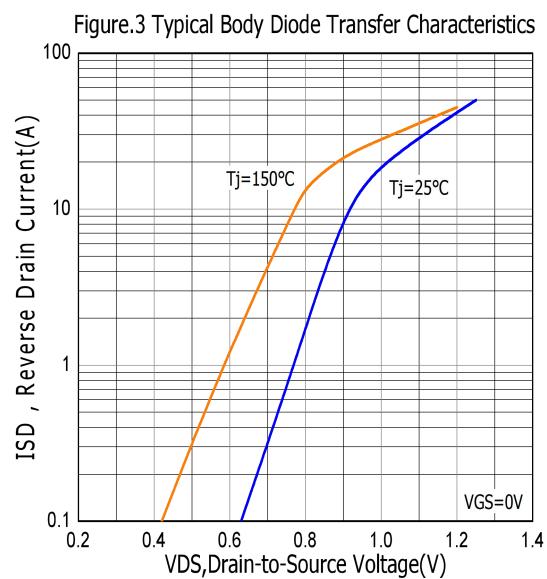
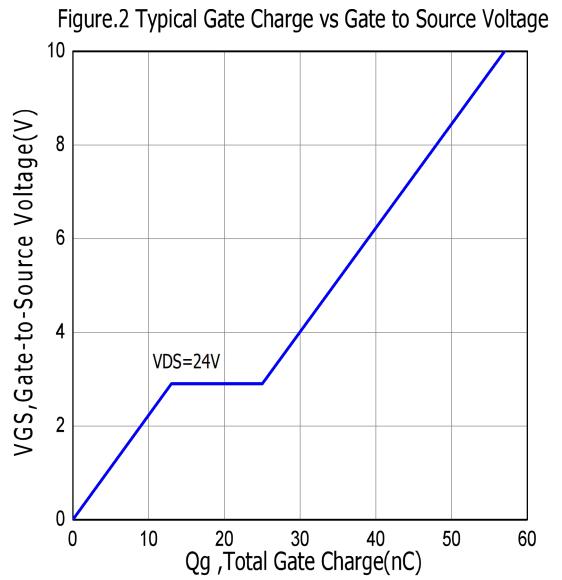
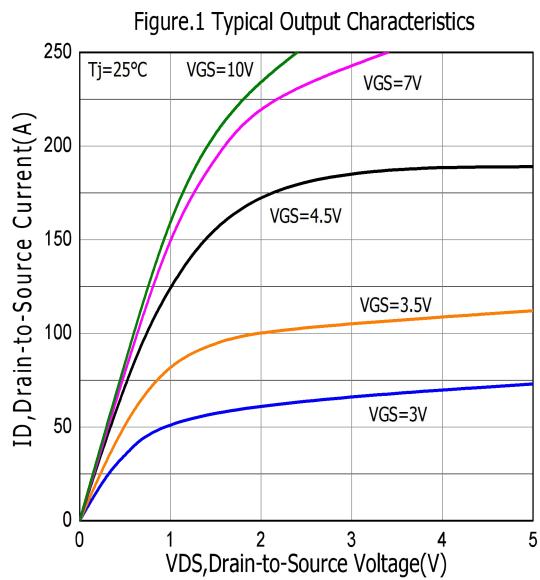


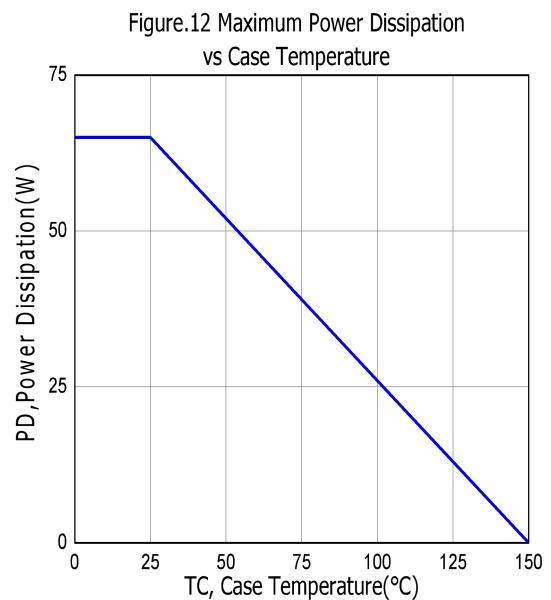
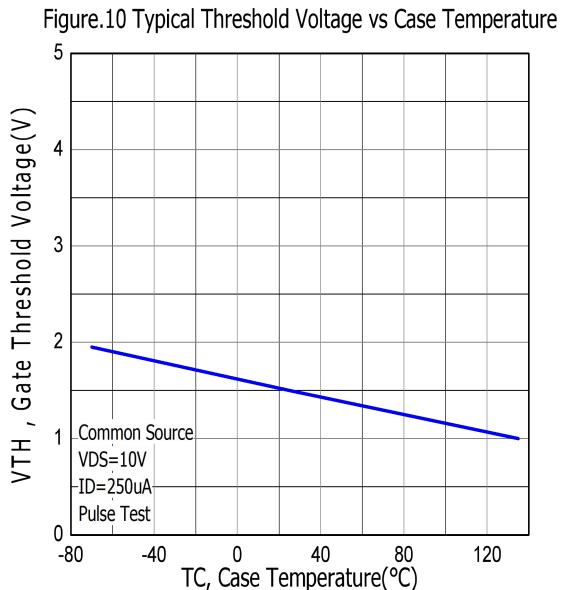
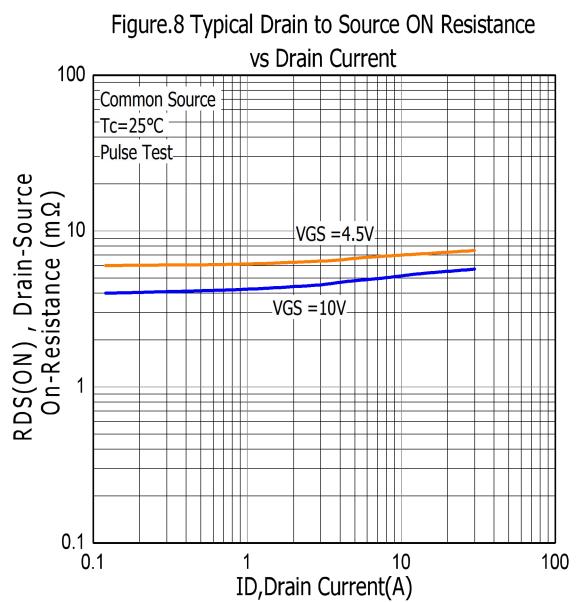
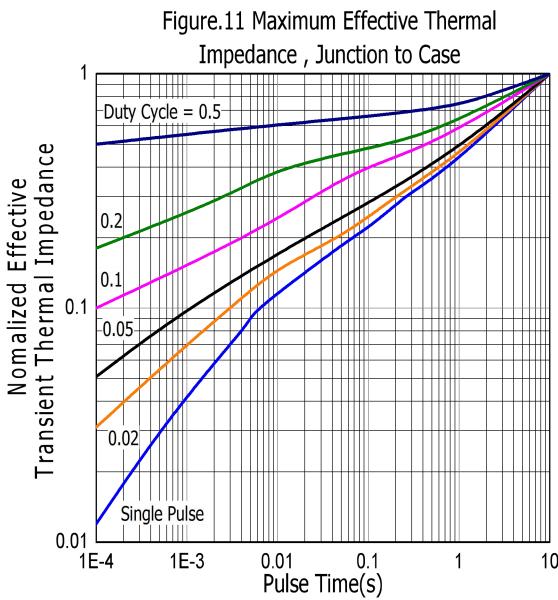
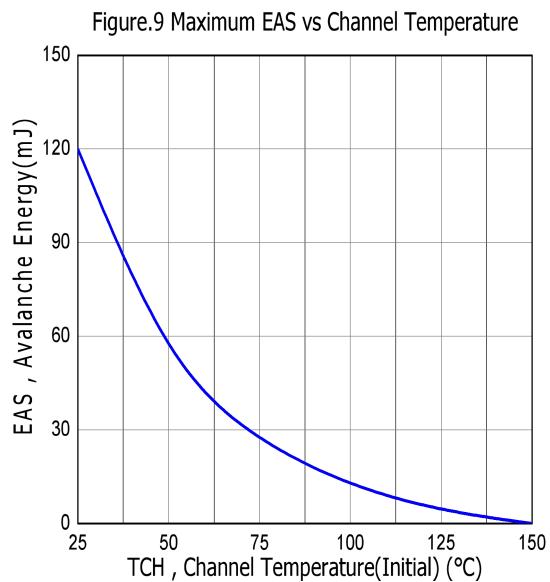
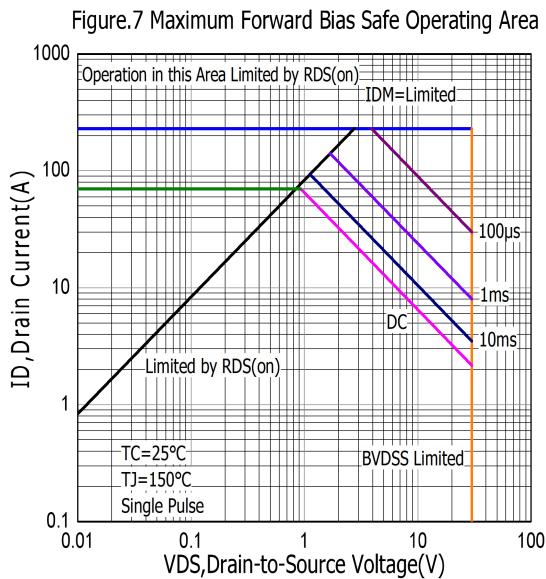
Unclamped Inductive Switching Test Circuit



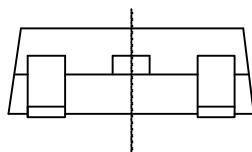
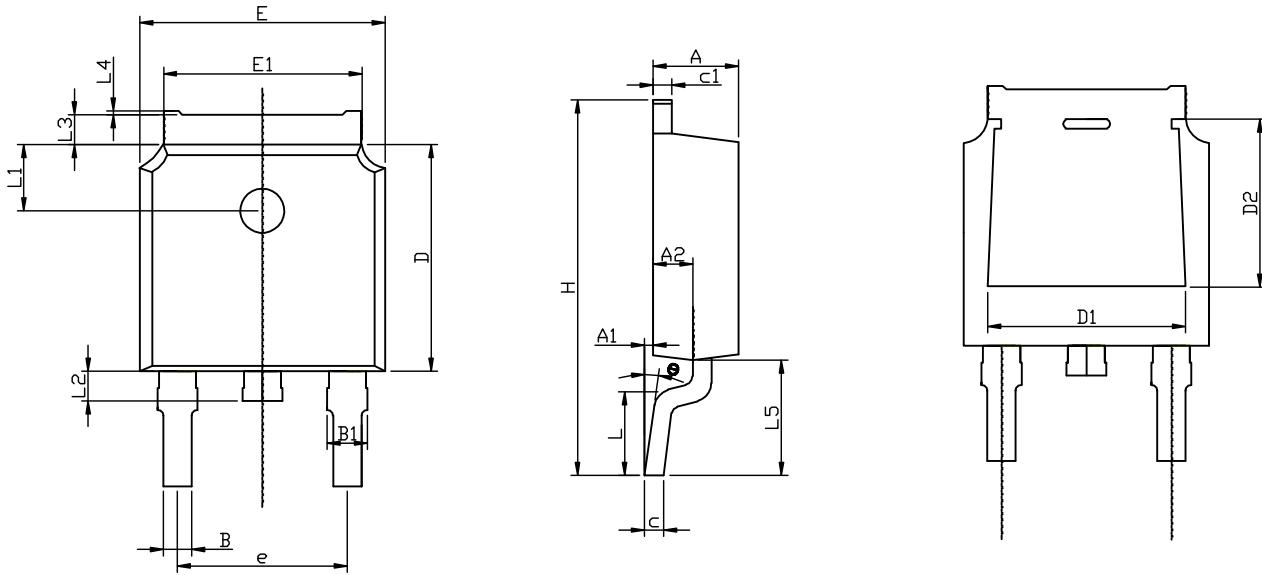
Unclamped Inductive Switching Waveforms

## RATING AND CHARACTERISTIC CURVES

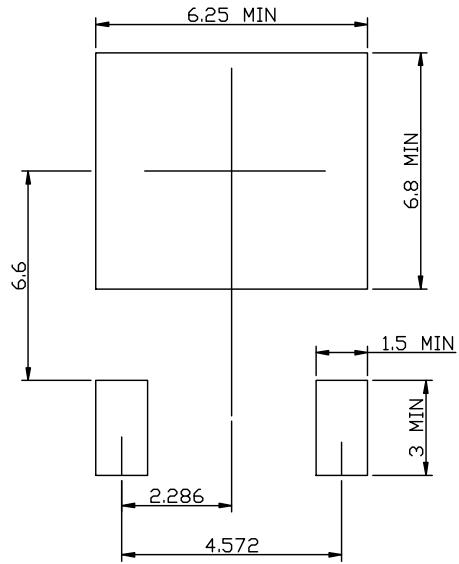




## TO-252-2L PACKAGE OUTLINE



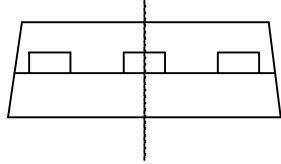
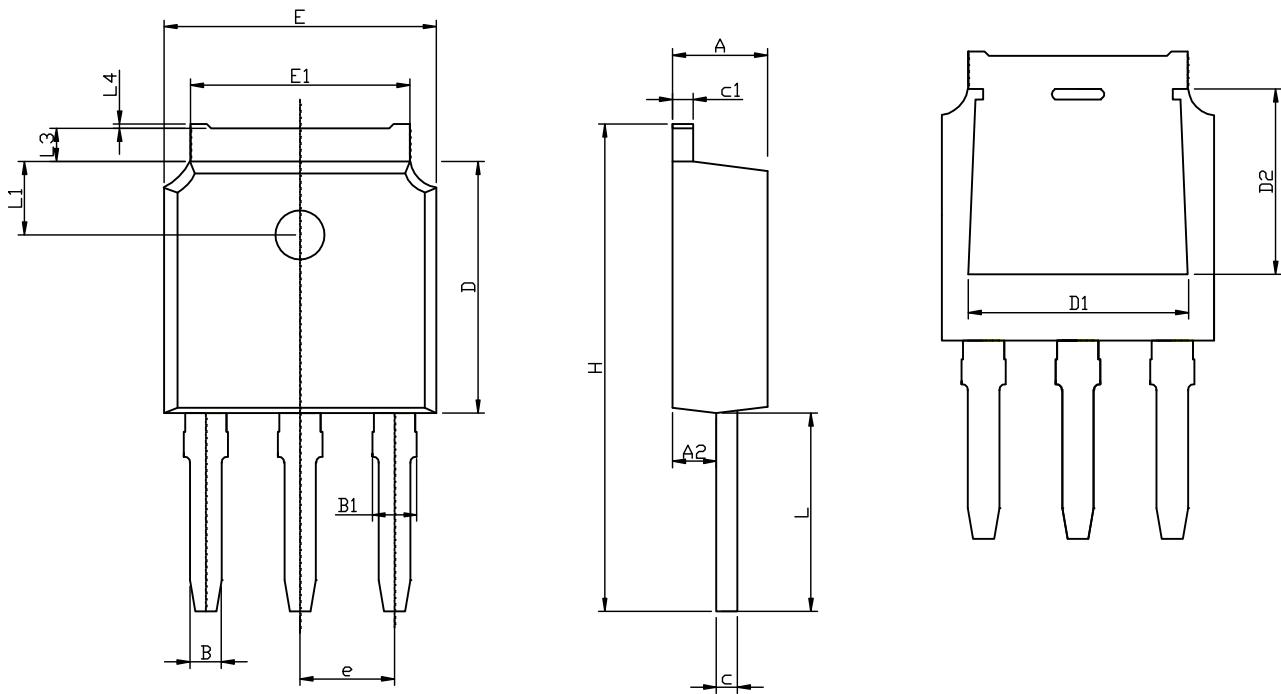
RECOMMENDED LAND PATTERN



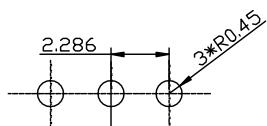
	MIN	NOM	MAX
A	2.15	2.30	2.45
A1	0.05	0.10	0.20
A2	0.91	1.07	1.22
B	0.66	0.76	0.86
B1	0.93	1.08	1.23
C	0.40	0.50	0.60
C1	0.40	0.50	0.60
D	5.95	6.10	6.25
D1	—	4.8REF	—
D2	—	3.8REF	—
E	6.45	6.60	6.75
E1	5.12	5.32	5.52
L		1.65	
L1	1.58	1.78	1.98
L2	0.60	0.80	1.00
L3	0.70	0.85	1.00
L4	0.00	0.05	0.20
L5	2.80	3.10	3.40
H	9.80	10.10	10.40
$\Theta$	0°		8°
e		4.572REF	

UNIT: mm

## TO-251-3L PACKAGE OUTLINE



RECOMMENDED LAND PATTERN



UNIT: mm

	MIN	NOM	MAX
A	2.15	2.30	2.45
A2	0.91	1.07	1.22
B	0.66	0.76	0.86
B1	0.93	1.08	1.23
C	0.40	0.50	0.60
C1	0.40	0.50	0.60
D	5.95	6.10	6.25
D1	-	4.8REF	-
D2	-	3.8REF	-
E	6.45	6.60	6.75
E1	5.12	5.32	5.52
L	4.50	4.80	5.10
L1	1.58	1.78	1.98
L3	0.70	0.85	1.00
L4	0.00	0.05	0.20
H	11.50	11.80	12.10
e		2.286REF	